NANO mXTEND^{TM}: MINIATURE AND HIGH EFFICIENCY BLUETOOTH/WI-FI ANTENNA

NANO mXTEND™

MINIATURE AND HIGH-EFFICIENCY BLUETOOTH/WI-FI ANTENNA
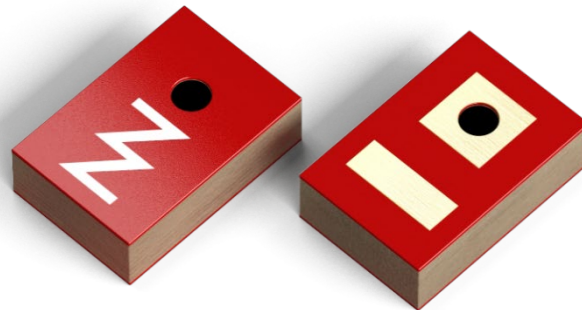
NN02-101

**NANO mXTEND™ | Bluetooth & Wi-Fi**

Operating range: 2400 – 10600 MHz

Best for: 2400 – 2500 MHz

Dimensions : 3.0 mm x 2.0 mm x 0.8 mm

What is the NANO mXTEND™?

The **NANO mXTEND™** is the smallest Virtual Antenna® chip to date. Featuring a size of only 3 mm x 2 mm x 0.8 mm, this off-the-shelf chip antenna has been designed to fit almost every **IoT device** from entry-level to high-end products. The **NANO mXTEND™** is enabled by Virtual Antenna® technology, thus featuring the unique properties of this class of products: easy to use; versatile, and broadly tunable. The **NANO mXTEND™** is available for Bluetooth, Wi-Fi, Wi-SUN, and any wireless connectivity protocol operating in the 2.4 - 2.5 GHz band. Due to Ignion's proprietary Virtual Antenna® technology, this chip antenna is non-resonant and therefore broadly tunable, enabling additional frequency bands to be supported by the same antenna part and released in the future.

As with every other Virtual Antenna® chip, the **NANO mXTEND™** is available through Ignion's **Antenna Intelligence Cloud** tool, enabling predictable design and performance throughout the entire product development cycle. Moreover, the **NANO mXTEND™** is built on a glass epoxy substrate, making its manufacturing broadly available and therefore resilient against shortage.
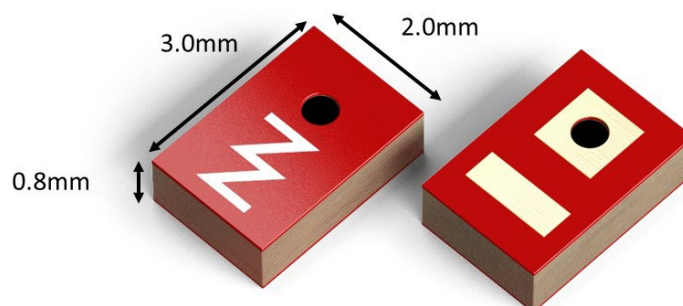
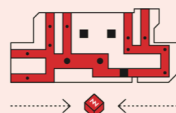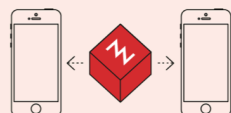**Material:** The NANO mXTEND™ antenna booster is built on a glass epoxy substrate.
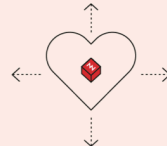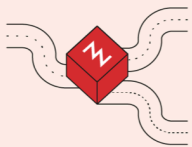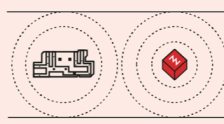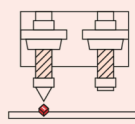
What is the NANO mXTEND™ used for?

The **NANO mXTEND™** is suitable for embedding an antenna into any wireless device requiring optimum performance in a small, cost-effective package for operating in the Bluetooth/Wi-Fi/Wi-SUN ISM 2.4 GHz frequency bands, including:

- Asset Trackers
- Smart Tags
- Earphones and Headsets
- Wearables
- Logistic Trackers
- Health sensors

- Animal Trackers
- Security Sensors
- Service Buttons
- Environmental Sensors
- IoT Developer Kits
- Wireless Sniffing Sensors

What differentiates the NANO mXTEND™ from other chip antennas?

Like every other Virtual Antenna® product, the NANO mXTEND™ is frequency neutral, meaning that its frequency response is not determined by the antenna component but designed by the electronics engineer. Virtual Antenna® technology provides the broadest range of connectivity options with desired antenna performance in the smallest ever form factor. This unique technology enables the whole mXTEND™ range of components to become tiny, off-the-shelf, surface-mount (SMD) electronic chips while still providing connectivity with multiple frequency bands and meeting the requirements of most wireless devices' architectures and form factors. Being non-resonant, the whole antenna performance can be customized through a shorter and easier design cycle by means of a matching circuit, while benefiting at the same time from a robust, reliable, and cost-effective manufacturing process because of the chip, SMD form factor. Also, the NANO mXTEND™'s architecture is not using ceramic materials to achieve miniaturization, which ensures a pervasive availability of raw materials thus making the supply chain resilient to shortage and price fluctuations.

Off-the-shelf
Ready to be delivered 'as is' with no need for customization.

Up to 10 times smaller
A booster can be 5^3mm³ providing the same connectivity.

Versatility
A phone can be designed with several architectures yet still using the same component.

Scalability
The 'heart' ot the design can be reused across multiple device models.

Modular
Modules or standard building blocks can be re-used in the design of multiple devices.

Multiband
A single antenna provides connectivity in 2G, 3G and 4G band.

Full performance
The same performance in a much smaller, off-the-shelf and versatile component.

Pick & place
No manual assembly is needed, only a conventional SMT machine.

ignion^{NN}

Click to view other useful NANO mXTEND™ guidelines:

5

HOW TO EMBED A VIRTUAL ANTENNA®

MECHANICAL SPECIFICATIONS

ASSEMBLY AND MANUFACTURING

PACKAGING
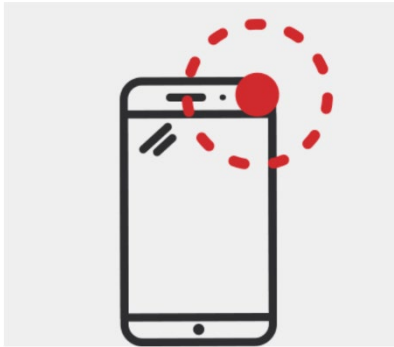
Chapter Index

How to embed Virtual Antenna®

Design with Virtual Antenna® in 1-2-3

STEP 1: Place the antenna component

1. Select one corner of your PCB
2. Ensure your ground plane meets the NANO mXTEND™ clearance area restrictions
3. Respect a keep out space around the booster. Keep at least 5mm distance from metallic objects

Look here for an example of antenna placement

STEP 2: Design your matching network

1. Through a combination of inductors & capacitors obtain 50 Ohms of antenna impedance to optimize the transfer of energy to your antenna
2. It is critical to fine-tune your MN throughout the entirety the design process to achieve your desired frequency response

Look here for an example of a matching network for a Virtual Antenna® product application via simulation

STEP 3: Test your device
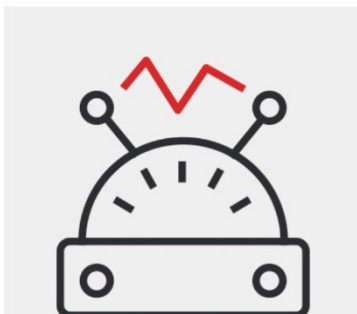
1. Perform a field test in which your antenna is placed in its final housing. Fine-tune the MN if needed.
2. Use a network analyzer to adjust mismatch
3. Test the antenna's efficiency with an anechoic chamber

Look here for a short video tutorial on how to test your antenna.

https://ignion.io/design-center/tutorials-webinars/

Scan this QR code to see our videos highlighting these three easy steps

Need further help? Easy start with Antenna Intelligence Cloud

Do you need more help with your antenna for your device?

Use our **Antenna Intelligence Cloud service** and get your ready-to-test, proof-of-concept antenna design especially simulated for your platform **free of charge[1]**, and in **24 hours**.

https://www.ignion.io/antenna-intelligence/

[1] Subject to terms and conditions here.

Scan QR code to be taken to our Antenna Intelligence Cloud page

The NANO mXTEND™ for Bluetooth/Wi-Fi

The NANO mXTEND™ has been designed for **Bluetooth/Wi-Fi** connectivity at 2.4 GHz**.** An optimum tuning of this chip at the 2.4 GHz band is achieved through a matching network. Due to its versatility, the chip antenna component can be mounted both on the corner or on the center of an edge of the printed circuit board (PCB) of your wireless device just by changing the matching network. The table below includes a quick reference guide for the antenna specifications on a reference design of 80 x 40 mm, as well as the set-up matching network and performance for both a corner and an edge mounting configuration.

QUICK REFERENCE GUIDE

Technical Specs for the NANO mXTEND™ in the corner configuration:

Technical features	2400 – 2500 MHz
Average Efficiency	>55 %
Peak Gain	2.4 dBi
VSWR	< 2.5:1
Radiation Pattern	Omnidirectional
Polarization	Linear
Weight (approx.)	0.01 g.
Temperature	-40 to +125 ºC
Impedance	50 Ω
Dimensions (L x W x H)	3.0 mm x 2.0 mm x 0.8 mm

Table 1 – Technical Features. Measurements from the evaluation board (Figure 1)

Technical Specs for the NANO mXTEND™ in the edge configuration:

Technical features	2400 – 2500 MHz
Average Efficiency	>65 %
Peak Gain	2.4 dBi
VSWR	< 3.0:1
Radiation Pattern	Omnidirectional
Polarization	Linear
Weight (approx.)	0.01 g.
Temperature	-40 to +125 ºC
Impedance	50 Ω
Dimensions (L x W x H)	3.0 mm x 2.0 mm x 0.8 mm

Table 2 – Technical Features. Measurements from the evaluation board (Figure 4)

CORNER MOUNTING CONFIGURATION

The NANO mXTEND™ is ready and recommended for corner mounting in those devices where this region is available for antenna placement. This section details a corner mounting design on a reference ground plane of 80 mm x 40 mm including a clearance area of 5 mm x 5 mm (Figure 1). Other ground plane sizes and clearances can be implemented by adapting the matching network.
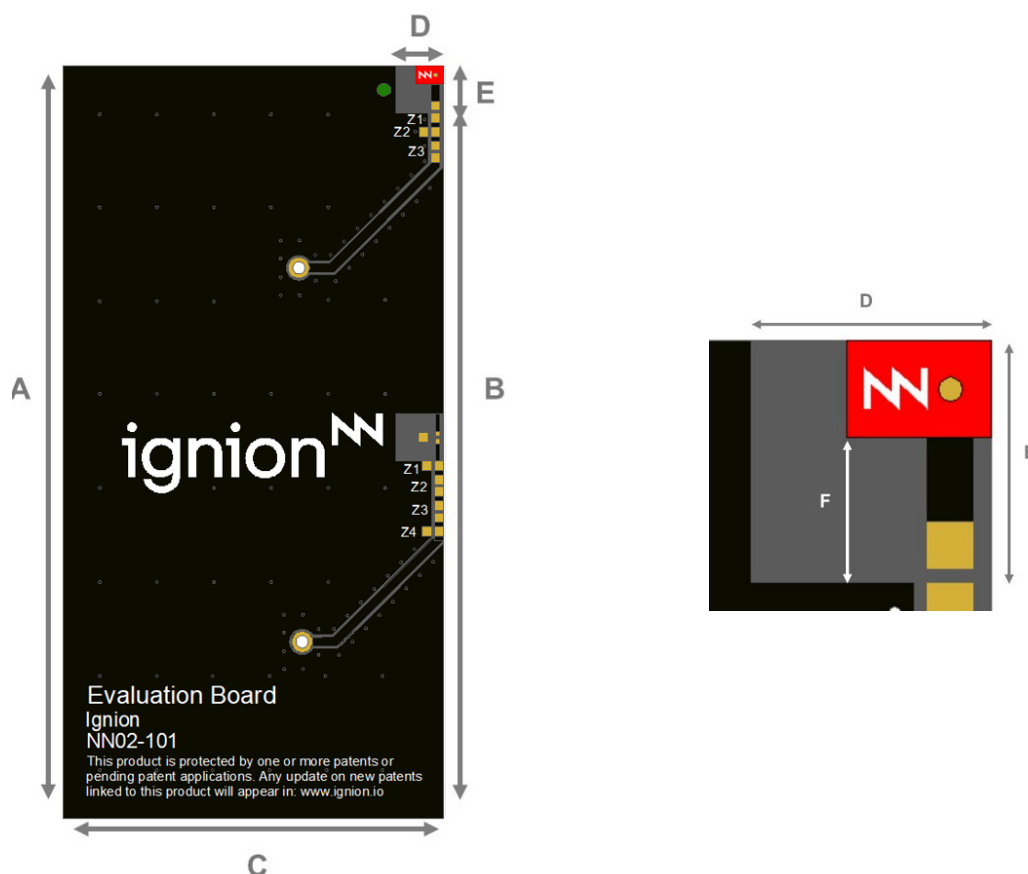
Measure	mm
A	80
B	75
C	40
D	5
E	5
F	3

Tolerance: ±0.2 mm

D: Length of clearance area.

Figure 1 - EB_NN02-101_c_BT. Evaluation board configured to provide operation at Bluetooth (2400 – 2500MHz).

This product and its use are protected by at least one or more of the following patents and patent applications PAT. US 62/529032; and other domestic and international patents pending.

MATCHING NETWORK

The NANO mXTEND™ antenna booster needs a matching network to ensure optimal performance in the 2.4 GHz – 2.5 GHz frequency range. This section presents a suitable matching network for the corner mounting configuration (Figure 7). Please note that different form factors, RF ground planes, and nearby components may require a different matching network.

If you need assistance to design your matching network beyond this application note, please contact support@ignion.io, or if you are designing a **different device size** or a **different frequency band**, **we can assist you** in less than 24 hours. Please, try our free-of-charge[1] Antenna Intelligence Cloud, which will get you a complete design report including a custom matching network for your device in 24h[1]. Additional information related to Ignion's range of R&D services is available at: https://ignion.io/rdservices/

2.4 GHz – 2.5 GHz	

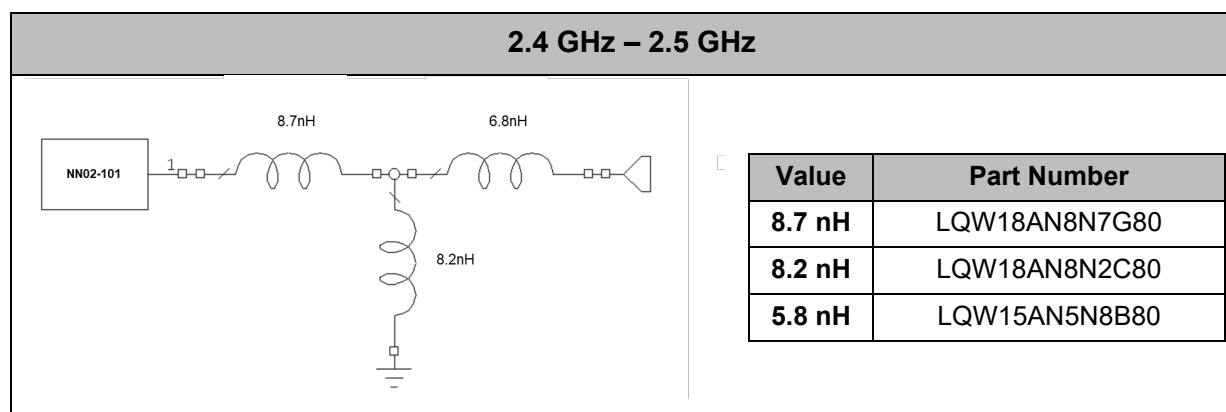| Value	Part Number
8.7 nH	LQW18AN8N7G80
8.2 nH	LQW18AN8N2C80
5.8 nH	LQW15AN5N8B80

Figure 2 – Matching network implemented on the Evaluation Board (Figure 1) for covering Bluetooth from 2.4GHz to 2.5GHz.

For an optimal result, the use of high-quality factor (Q) and tight tolerance components is highly recommended (e.g., Murata components with part numbers as shown in **Figure 2**). The antenna performance is always conditioned by its operating environment meaning that differences in the device, including differences in printed circuit board sizes, components near the antenna, displays, batteries, covers, connectors, etc. affect the antenna performance. Accordingly, placing pads compatible with 0402 and 0603 SMD components for a matching network as close as possible to the feeding point of the antenna element is highly recommendable. It is also recommendable to do this in the ground plane area, not in the clearance area. By tuning the matching network in your final design after your final surrounding components are in place (batteries, displays, covers, etc.) you will be able to optimize the antenna performance without changing the antenna part or the design.

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[1] See terms and conditions for a free Antenna Intelligence Cloud service in 24h at: https://www.ignion.io/antenna-intelligence/

VSWR AND TOTAL EFFICIENCY

VSWR (Voltage Standing Wave Ratio) and Total Efficiency versus Frequency (GHz).
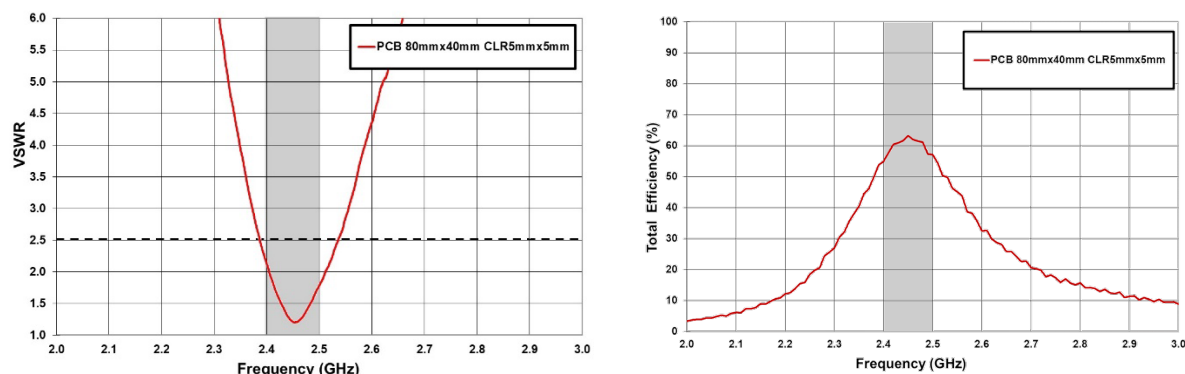
Figure 3 - VSWR and Total Efficiency for the 2.4 – 2.5 GHz frequency range as observed on the evaluation board EB_NN02-101_c_BT (Figure 1).

NANO mXTEND™	2.4 – 2.5GHz				
	η_a 2400MHz	η_a 2500MHz	**Min**	**Max**	**Av. η_a**
On the corner	54.9	57.1	54.9	63.2	60.1

Table 3 - Antenna efficiency comparison considering the evaluation board EB_NN02-101_c_BT (Figure 1).

The NANO mXTEND™ operates at the required Bluetooth/Wi-Fi frequency spectrum with high-efficiency values. Please note that its high performance can be sustained even with a reduced clearance area.

RADIATION PATTERNS, GAIN, AND EFFICIENCY

	Measurement System Set-Up Evaluation Board in Plane XY	θ = 90º Plane XY at 2450 MHz

φ = 0º Plane XZ at 2450 MHz	φ = 90º Plane YZ at 2450 MHz
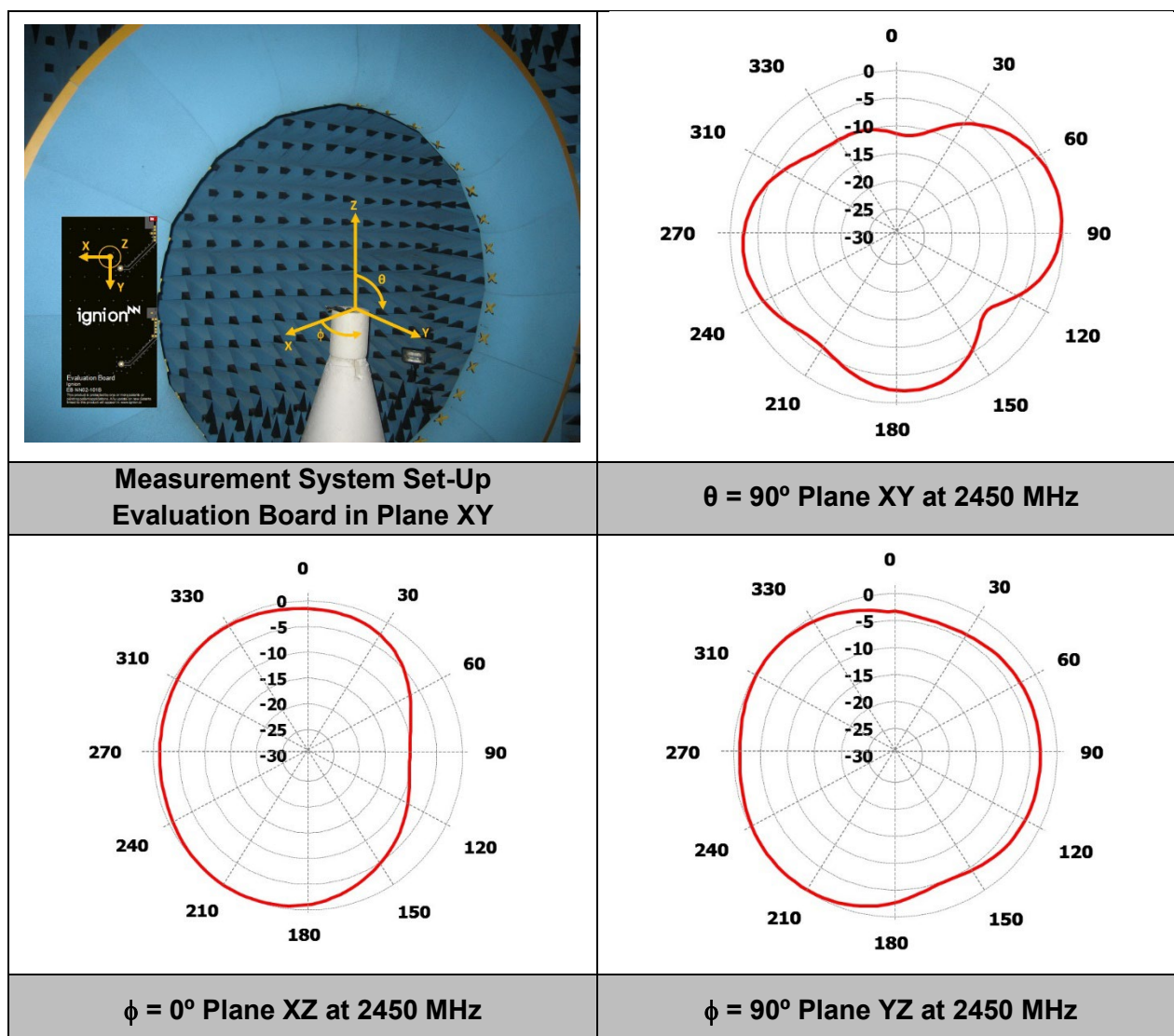
Gain	Peak Gain	2.4 dBi
	Average Gain across the band	2.2 dBi
	Gain Range across the band (min, max)	1.9 dBi <–> 2.4 dBi
Efficiency	Peak Efficiency	75.4 %
	Average Efficiency across the band	71.9 %
	Efficiency Range across the band (min, max)	66.3 – 75.4 %

Table 4 – Antenna Gain and total efficiency from the evaluation board (Figure 1) Bluetooth band. Measurements made in the STARLAB 18 anechoic chamber.

EDGE MOUNTING CONFIGURATION

In devices such as dual-hand gaming handhelds and landscape handheld devices, the center of the edge can be the ideal placement area for your chip antenna, This section details a design example and evaluation board (80 mm x 40 mm with 4 mm x 4 mm of ground clearance) in such an edge mounting configuration (Figure 4).

Measure	mm
A	80
B	40
C	5
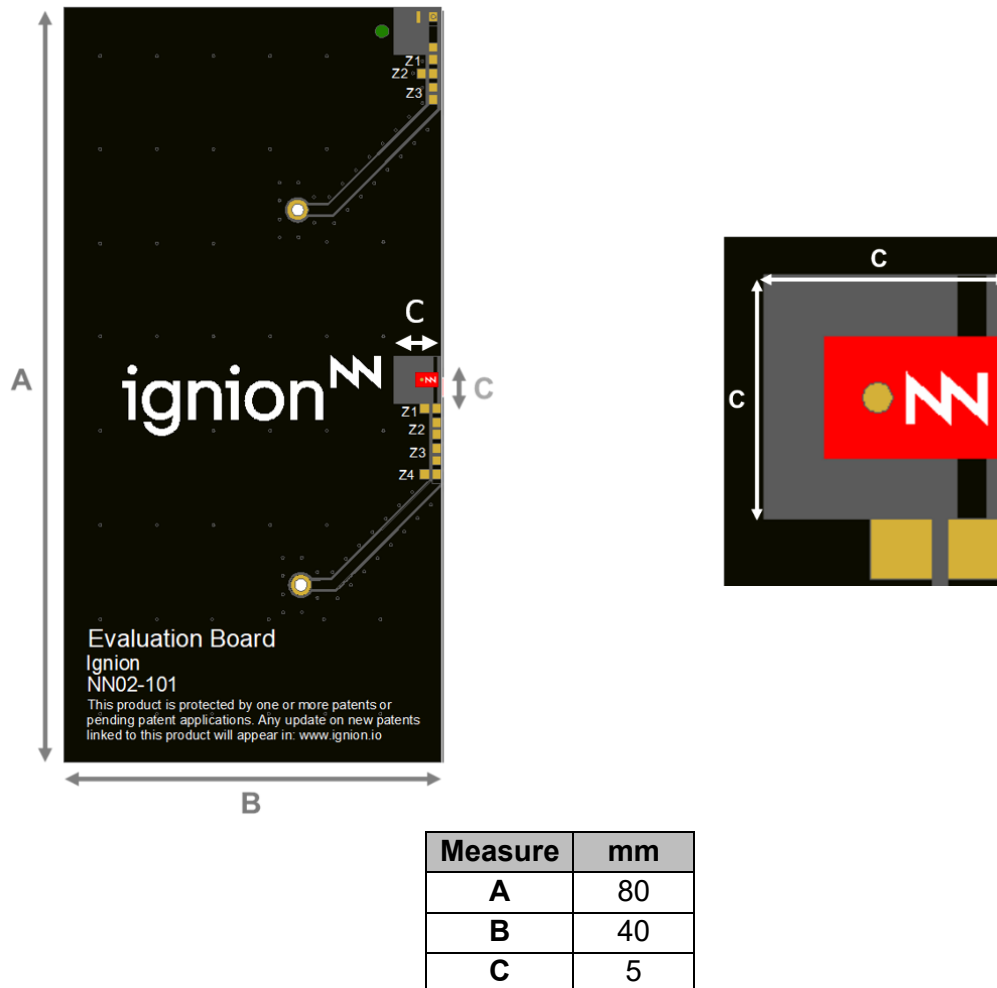
Tolerance: ±0.2 mm

C: Length of clearance area.

Figure 4 - EB_NN02-101_m_BT. Evaluation board providing operation at Bluetooth (2400 – 2500 MHz).

MATCHING NETWORK

By simply changing the matching network, the NANO mXTEND™ can also deliver optimal performance in an edge mounting configuration. A suitable matching network for edge mounting in the reference board pictured above is shown in Fig.5. Please note that different form factors of your wireless device and its RF ground planes, and the proximity of other elements such as shields, covers, connectors and the like might result in the need for a fine-tuning of the matching network.

If you need assistance to design your matching network beyond this application note, please contact support@ignion.io, or if you are designing a **different device size** or a **different frequency band**, **we can assist you** in less than 24 hours. Please, try our free-of-charge[1] Antenna Intelligence Cloud, which will get you a complete design report including a custom matching network for your device in 24h[2]. Additional information related to Ignion's range of R&D services is available at: https://ignion.io/rdservices/

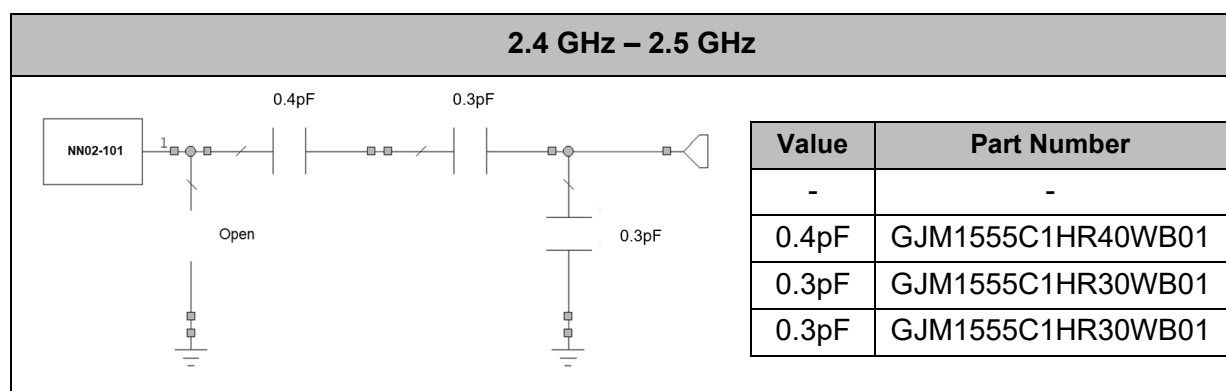| 2.4 GHz – 2.5 GHz		
	Value	**Part Number**
	-	-
	0.4pF	GJM1555C1HR40WB01
	0.3pF	GJM1555C1HR30WB01
	0.3pF	GJM1555C1HR30WB01

Figure 5 – Matching network implemented in the Evaluation Board (Figure 4) for covering Bluetooth from 2.4GHz to 2.5GHz.

To ensure optimal results, the use of high-quality factor (Q) and tight tolerance components is highly recommended (e.g. Murata components with part numbers as shown in **Figure 5**). The antenna performance is always conditioned by its operating environment meaning that differences in the device, including differences in printed circuit board sizes, components near the antenna, displays, batteries, covers, connectors, etc. affect the antenna performance. Accordingly, placing pads compatible with 0402 and 0603 SMD components for a matching network as close as possible to the feeding point of the antenna element is highly recommendable. It is recommended to do this in the ground plane area, not in the clearance area. By tuning the matching network in your final design after your final surrounding components are in place (batteries, displays, covers, etc.) you will be able to optimize the antenna performance without changing the antenna part, or the design.

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[2] See terms and conditions for a free Antenna Intelligence Cloud service in 24h at: https://www.ignion.io/antenna-intelligence/

VSWR AND TOTAL EFFICIENCY

VSWR (Voltage Standing Wave Ratio) and Total Efficiency versus Frequency (GHz).
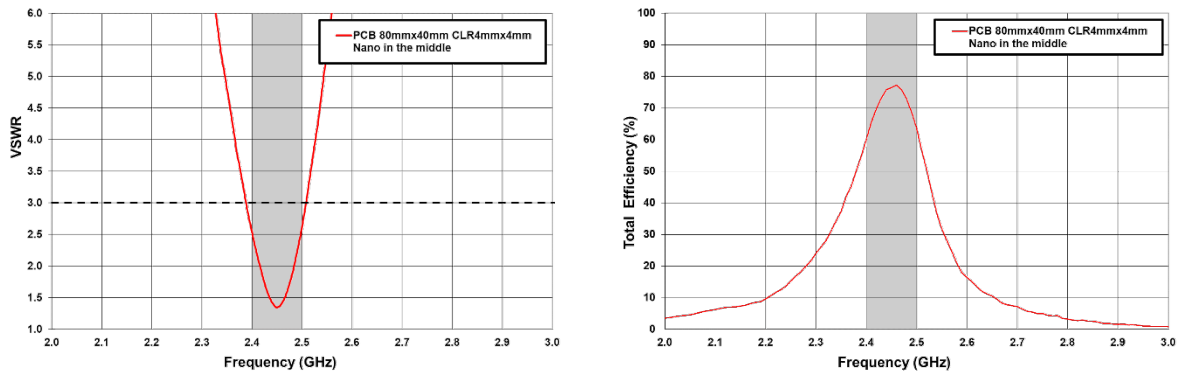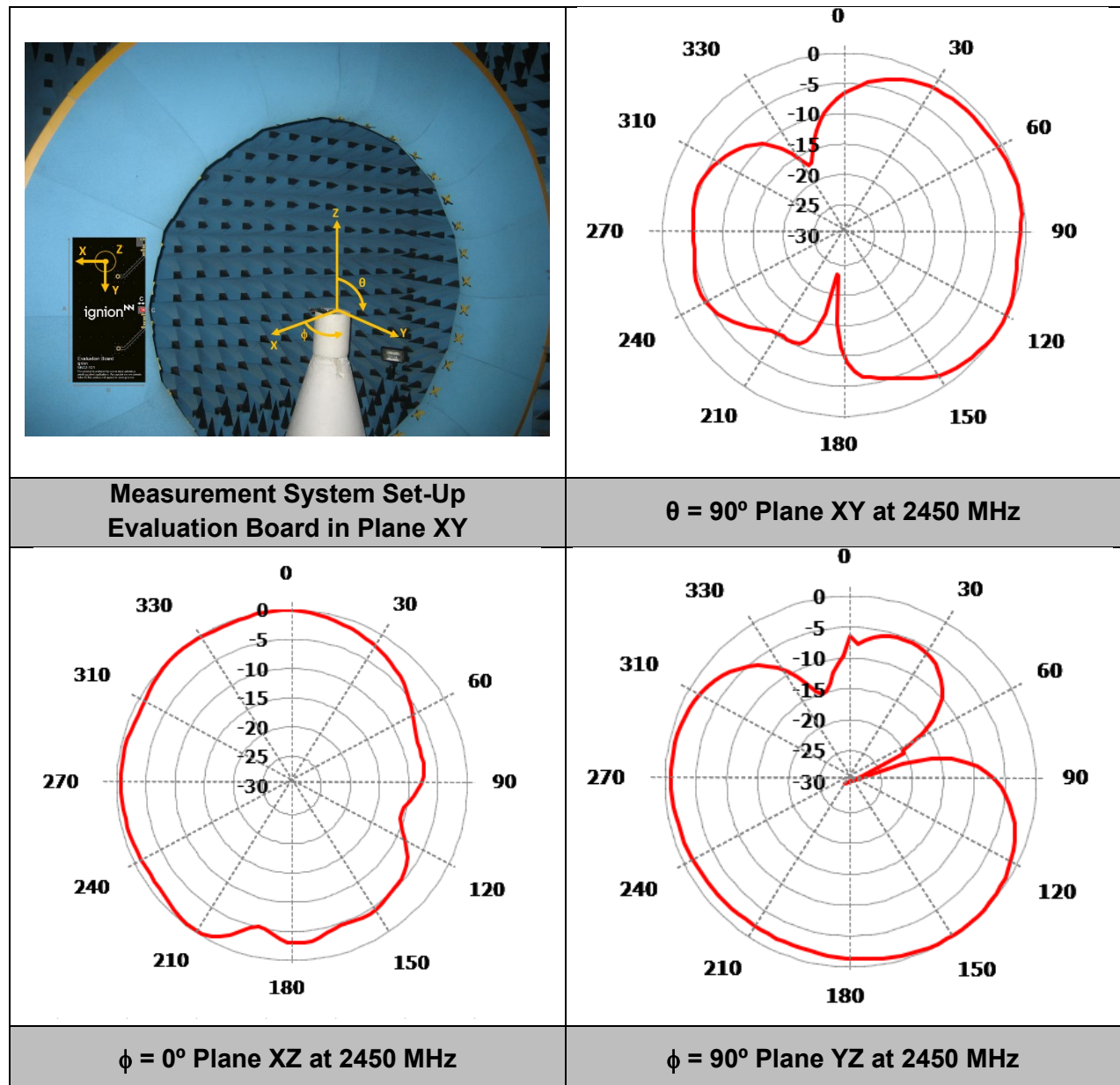

Figure 6 - VSWR and Total Efficiency for the 2.4 – 2.5 GHz frequency range configured to provide operation the evaluation board EB_NN02-101_m_BT (Figure 4).

NANO mXTEND™	2400 – 2500 MHz				
	$\eta_{a\ 2400MHz}$	$\eta_{a\ 2500MHz}$	**Min**	**Max**	**Av. η_a**
On the middle	60.1	63.6	60.1	77.3	71.7

Table 5 - Antenna efficiency comparison configured to provide operation the evaluation board EB_NN02-101_m_BT (Figure 4).

The NANO mXTEND™ operates at the required Bluetooth/Wi-Fi frequency spectrum with high efficiency values. Please note that its high performance can be sustained even with the small 5x5 mm clearance area.

RADIATION PATTERNS, GAIN, AND EFFICIENCY

Measurement System Set-Up Evaluation Board in Plane XY	θ = 90º Plane XY at 2450 MHz

ϕ = 0º Plane XZ at 2450 MHz	ϕ = 90º Plane YZ at 2450 MHz

Gain	**Peak Gain**	1.1 dBi
	Average Gain across the band	0.85 dBi
	Gain Range across the band (min, max)	0.3 dBi **<–>** 1.1 dBi
Efficiency	**Peak Efficiency**	73.7 %
	Average Efficiency across the band	69.6 %
	Efficiency Range across the band (min, max)	70.0 – 73.7 %

Table 6 – Antenna Gain and total efficiency from the evaluation board (Figure 4) Bluetooth band. Measurements made in the STARLAB 18 anechoic chamber.

MECHANICAL SPECIFICATIONS
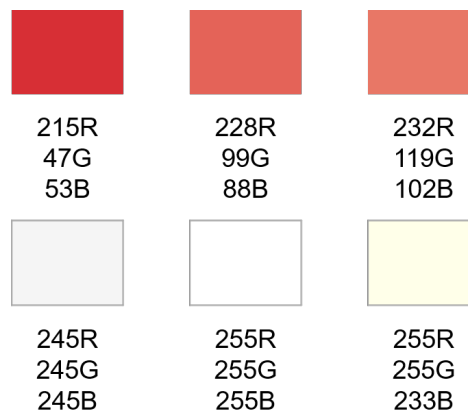
DIMENSIONS, TOLERANCES, AND RoHS

TOP   **SIDE**   **BOTTOM**
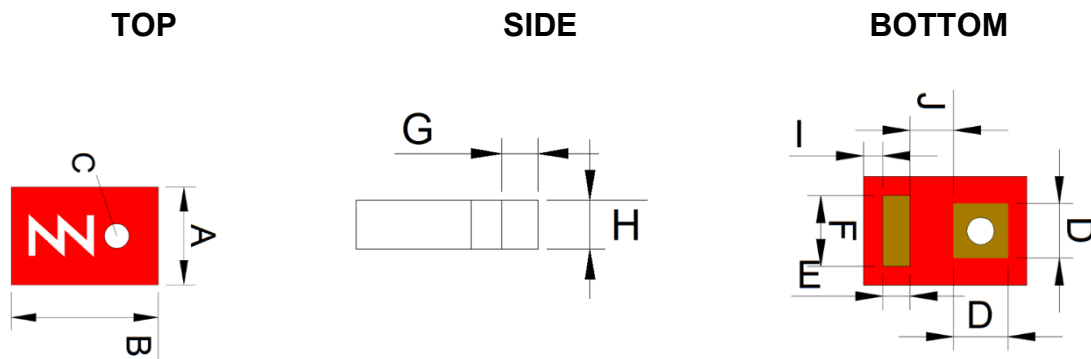
Dimension	mm	Dimension	mm
A	2.0	B	3.0
C	0.25	D	1.0
E	0.5	F	1.3
G	0.6	H	0.8
I	0.35	J	0.8

Figure 7 - NANO mXTEND^{TM} antenna booster dimensions and tolerances.

The NANO mXTEND^{TM} (NN02-101) antenna booster is compliant with the restriction of the use of hazardous substances (**RoHS**). For more information, please contact info@ignion.io.

INK COLOR RANGE

The next figure shows the range of colors in the NANO mXTEND^{TM} antenna booster:

215R
47G
53B

228R
99G
88B

232R
119G
102B

245R
245G
245B

255R
255G
255B

255R
255G
233B

Acceptable color range

RECOMMENDED FOOTPRINT FOR THE NN02-101

See below the recommended footprint dimensions for the **NANO mXTEND™** (NN02-101) antenna booster on the **corner**.

Measure	mm
A	1.0
B	0.5
C	1.3
D	0.8
E	0.15
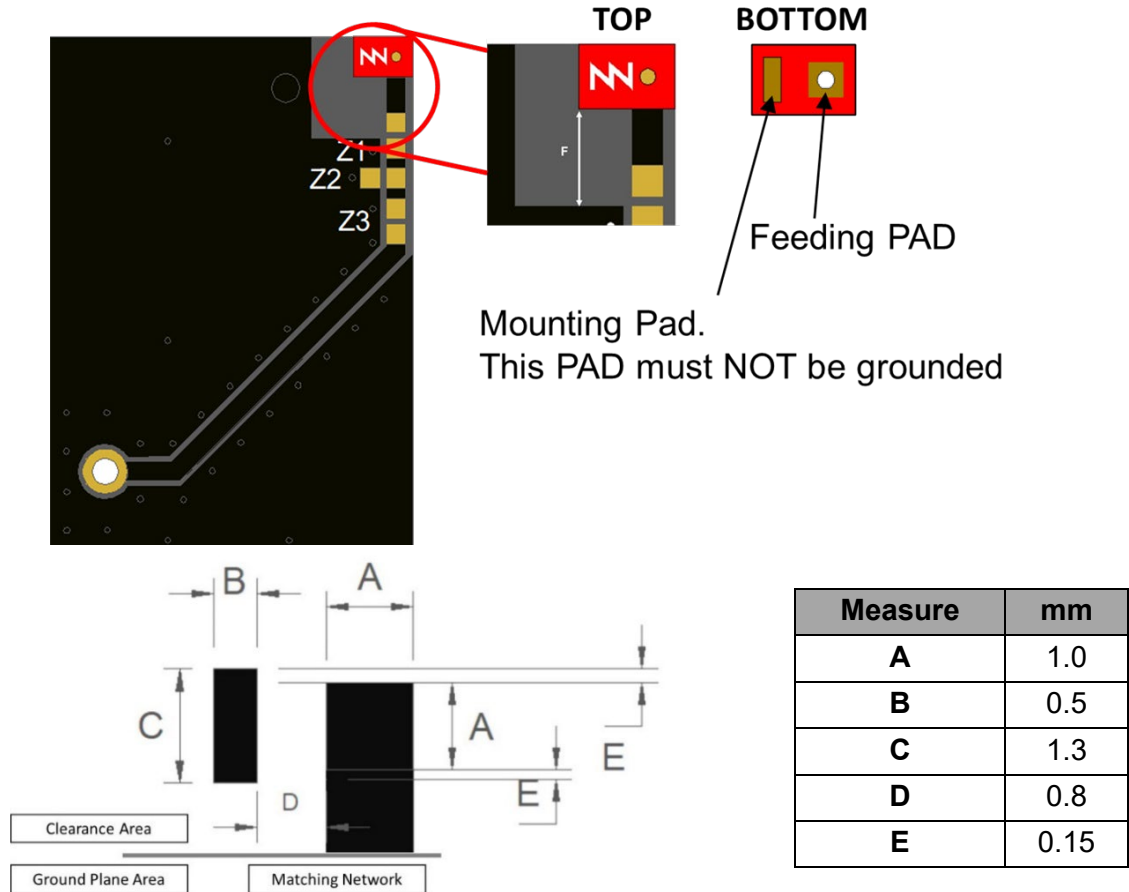
Tolerance: ±0.05mm

Figure 8 - Footprint dimensions for the NANO mXTEND™ (NN02-101) antenna booster (on the corner).

See below the recommended footprint dimensions for the **NANO mXTEND**^{TM} (NN02-101) antenna booster in the **middle**.

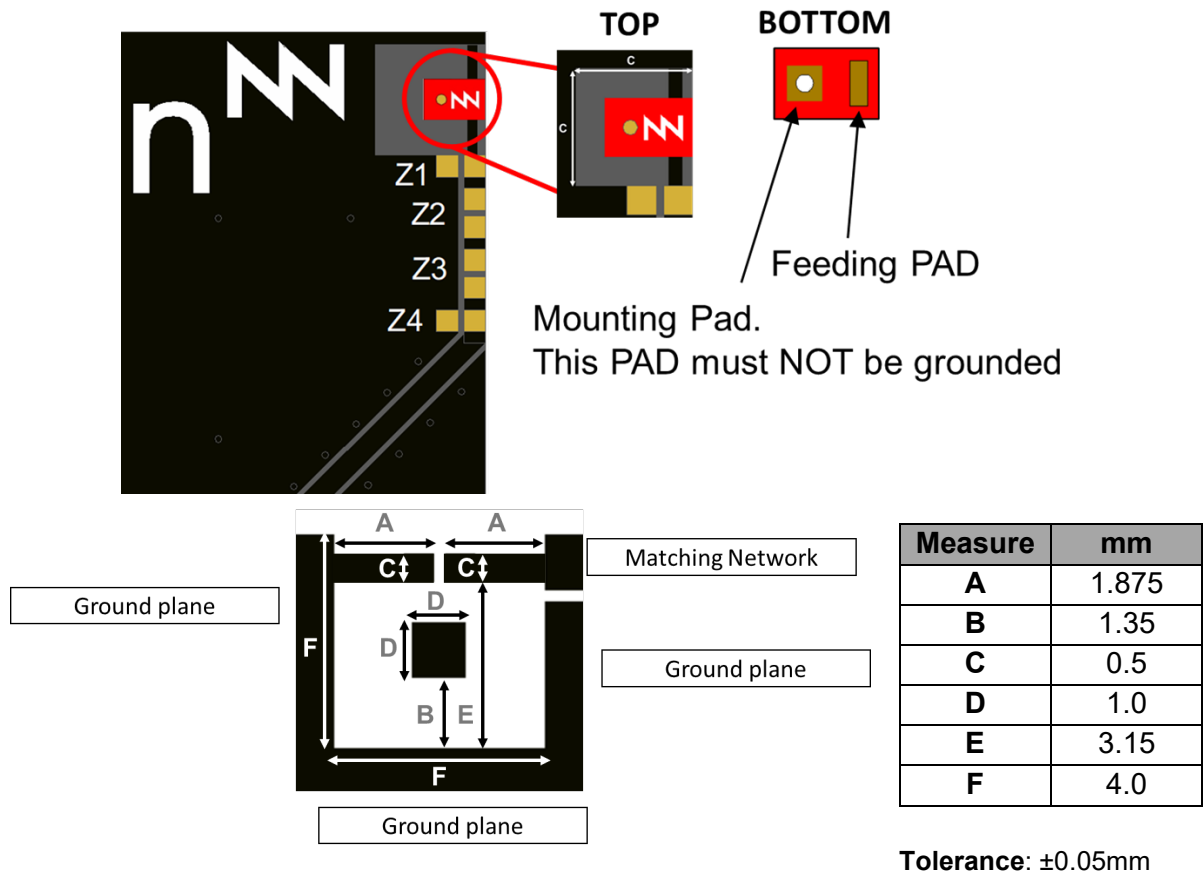| Measure	mm
A	1.875
B	1.35
C	0.5
D	1.0
E	3.15
F	4.0

Tolerance: ±0.05mm

Figure 9 - Footprint dimensions for the NANO mXTEND™ (NN02-101) antenna booster (on the middle).

For additional support in the integration process, please contact support@ignion.io.

ASSEMBLY AND MANUFACTURING

Figure 10 shows the back and front views of the NANO mXTEND™ (NN02-101) antenna booster.
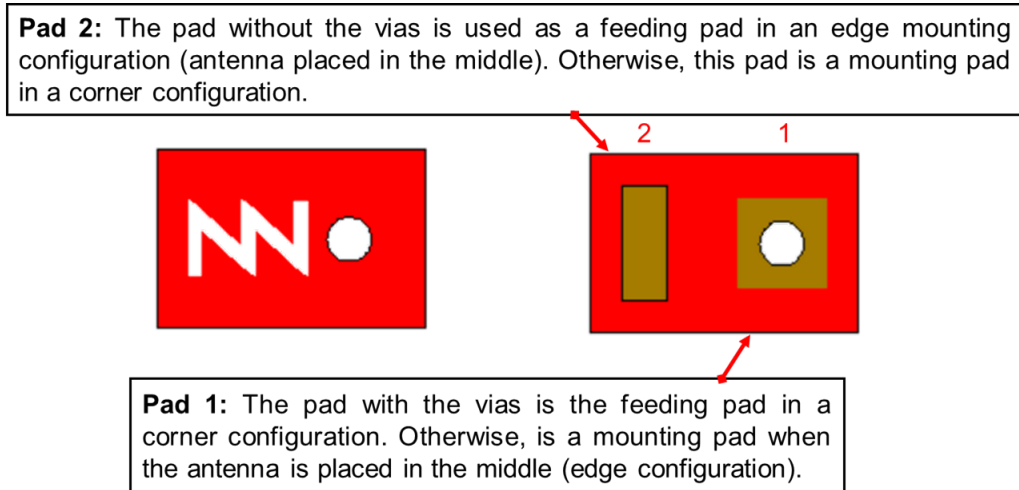
Pad 2: The pad without the vias is used as a feeding pad in an edge mounting configuration (antenna placed in the middle). Otherwise, this pad is a mounting pad in a corner configuration.

Pad 1: The pad with the vias is the feeding pad in a corner configuration. Otherwise, is a mounting pad when the antenna is placed in the middle (edge configuration).

Figure 10 – Pads of the NANO mXTEND™ (NN02-101) antenna booster.

As a surface mount device (SMD), the NANO mXTEND™ antenna booster is compatible with industry standard soldering processes. The basic assembly procedure for the NANO mXTEND™ antenna booster is as follows:

1. Apply a solder paste on the pads of the PCB. Place the NANO mXTEND™ antenna booster on the board.
2. Perform a reflow process according to the temperature profile detailed in Figure 11.
3. After soldering the NANO mXTEND™ antenna booster to the circuit board, perform a cleaning process to remove any residual flux. Ignion recommends conducting a visual inspection after the cleaning process to verify that all reflux has been removed.

The figure below shows the soldering details obtained after a correct assembly process:
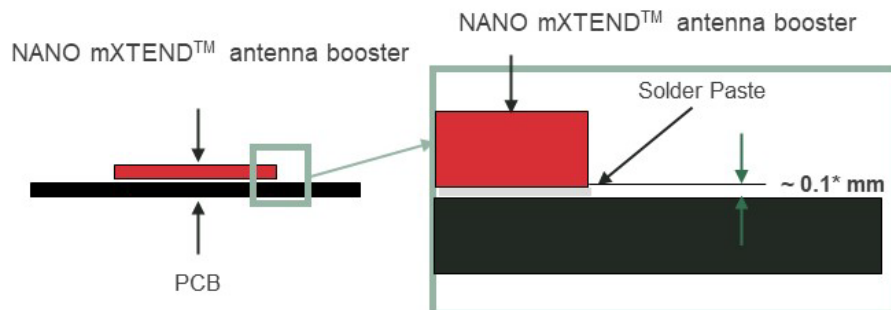

Figure 11 - Soldering details

NOTE (*): Solder paste thickness after the assembly process will depend on the thickness of the soldering stencil mask. A stencil thickness equal to or larger than 127 microns (5 mils) is required.

The NANO mXTEND™ (NN02-101) antenna booster can be assembled following the Pb-free assembly process. According to the **IPC/JEDEC J-STD-020C** Standard, the suggested temperature profile is as follows:

Phase	Profile features	Pb-Free assembly (Sn Ag Cu)
RAMP-UP	Avg. Ramp-up Rate (Tsmax to Tp)	3 ºC / second (max.)
PREHEAT	- Temperature Min (Tsmin) - Temperature Max (Tsmax) - Time (tsmin to tsmax)	150 ºC 200 ºC 60-180 seconds
REFLOW	- Temperature (TL) - Total Time above TL (tL)	217 ºC 60-150 seconds
PEAK	- Temperature (Tp) - Time (tp)	260 ºC 20-40 seconds
RAMP-DOWN	Rate	6 ºC/second max
Time from 25 ºC to Peak Temperature		8 minutes max

Table 7 – Recommended soldering temperatures.

The next graphic shows the temperature profile (grey zone) for the NANO mXTEND™ antenna booster assembly process reflow ovens.
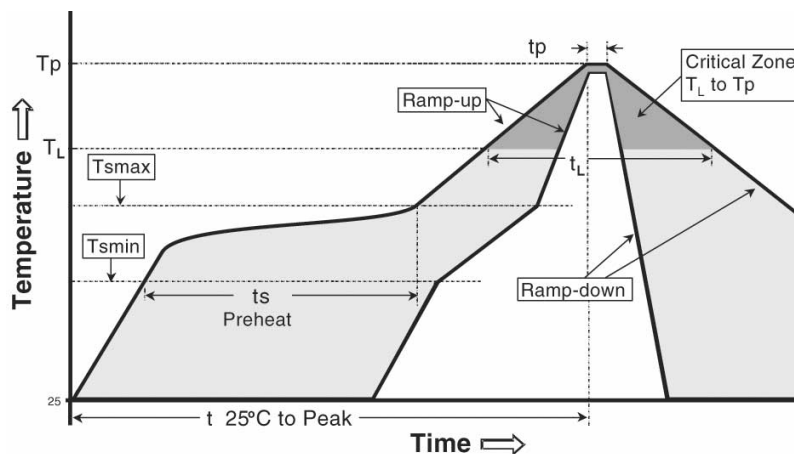

Figure 12 – Temperature profile

PACKAGING

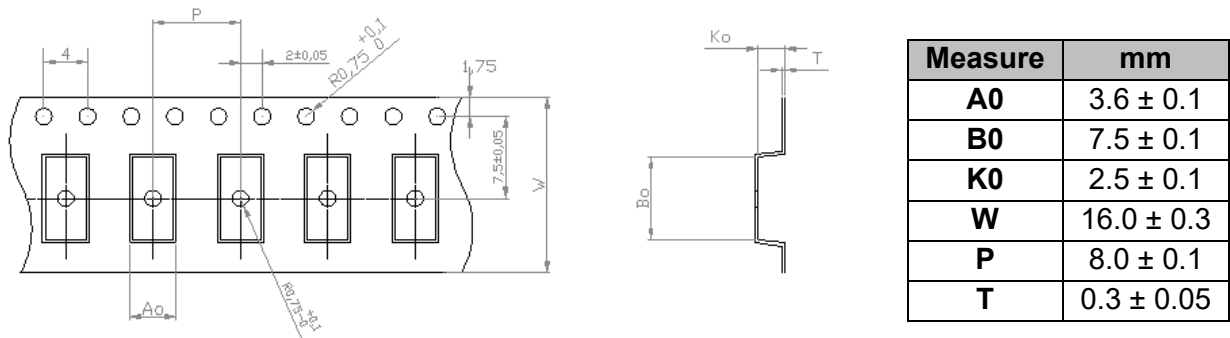The NANO mXTEND™ (NN02-101) antenna booster is delivered in tape and reel packaging.

Measure	mm
A0	3.6 ± 0.1
B0	7.5 ± 0.1
K0	2.5 ± 0.1
W	16.0 ± 0.3
P	8.0 ± 0.1
T	0.3 ± 0.05

Figure 13 - Tape dimensions and tolerances.

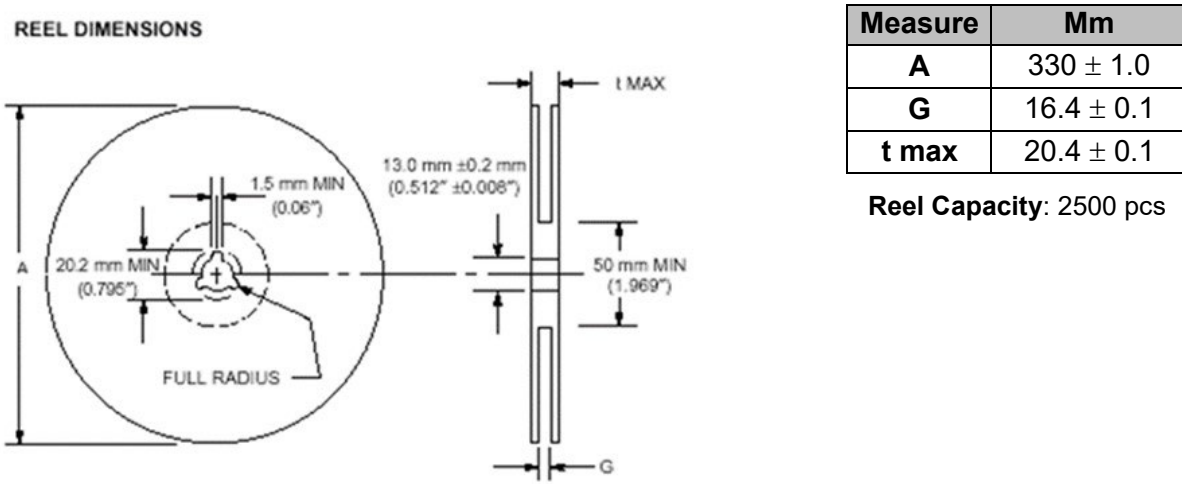| Measure	Mm
A	330 ± 1.0
G	16.4 ± 0.1
t max	20.4 ± 0.1

Reel Capacity: 2500 pcs

Figure 14 - Reel dimensions and capacity.

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Ignion is an ISO 9001:2015 certified company. All our antennas are lead-free and RoHS compliant.

ISO 9001: 2015 Certified

ignion

Your innovation.
Accelerated.

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support@ignion.io
+34 935 660 710

Barcelona

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